

## FEATURES

- | Low Zener Impedance

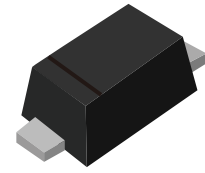
---

- | Power Dissipation of 150mW

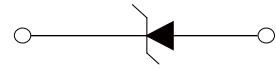
---

- | High Stability and High Reliability

---

SOD-523



Schematic Symbol

## APPROVALS

<b>RoHS</b>	Compliance with 2011/65/EU
<b>HF</b>	Compliance with IEC61249-2-21:2003

## MAXIMUM RATINGS ( $T_A=25^{\circ}\text{C}$ )

Parameter	Symbo	Value	Unit
Power Dissipation	$P_D$	150	mW
Maximum forward voltage at $I_F=10\text{mA}$	$V_F$	0.9	V
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	833	$^{\circ}\text{C}/\text{W}$
Storage temperature range	$T_J, T_{STG}$	-55 to +150	$^{\circ}\text{C}$

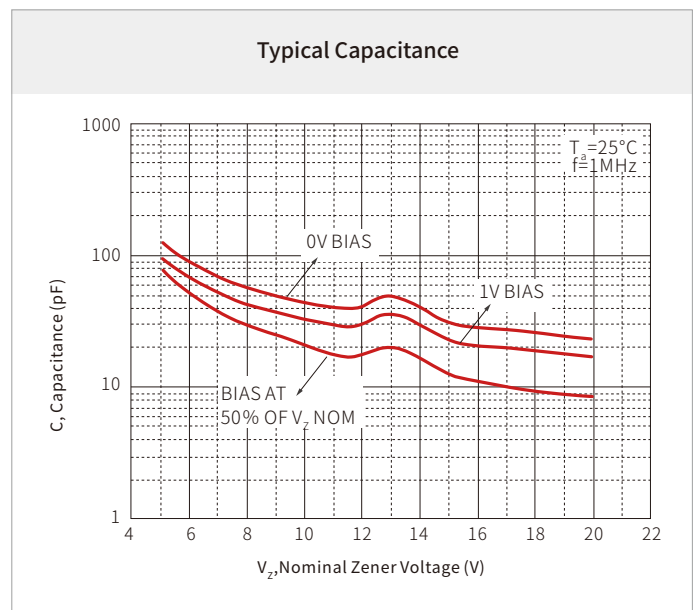
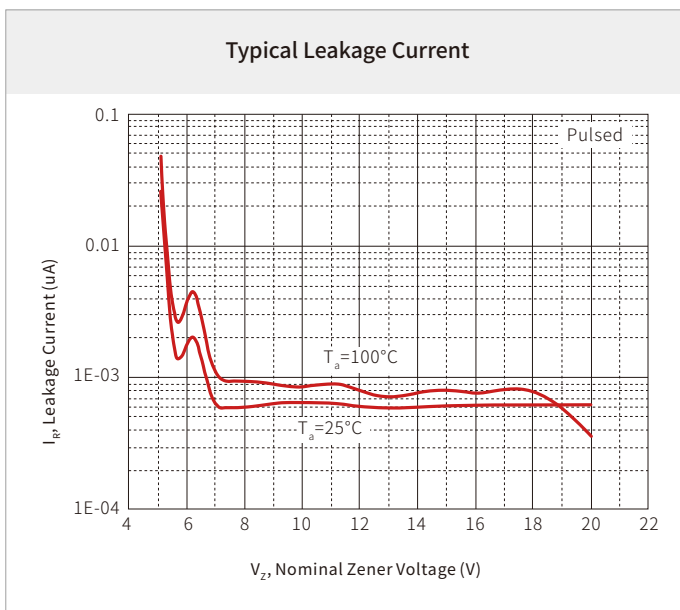
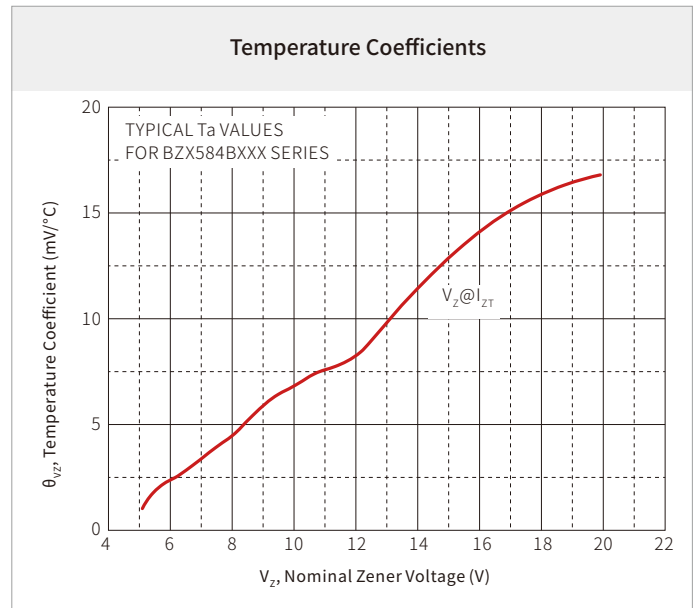
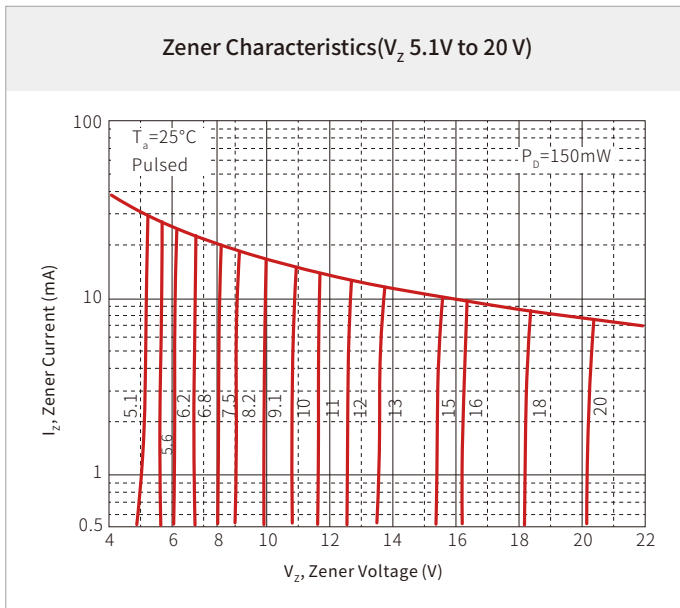
# ELECTRICAL CHARACTERISTICS

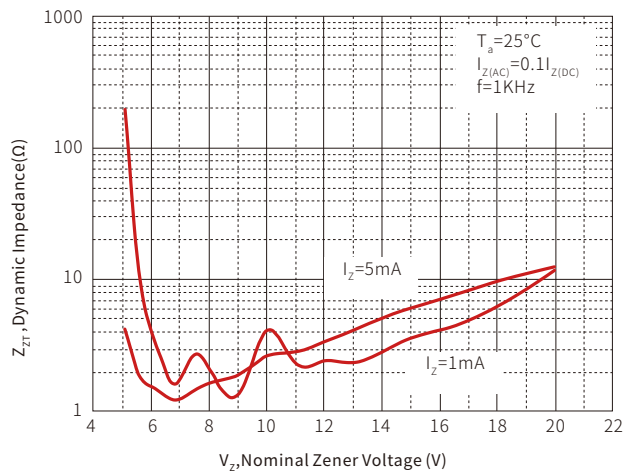
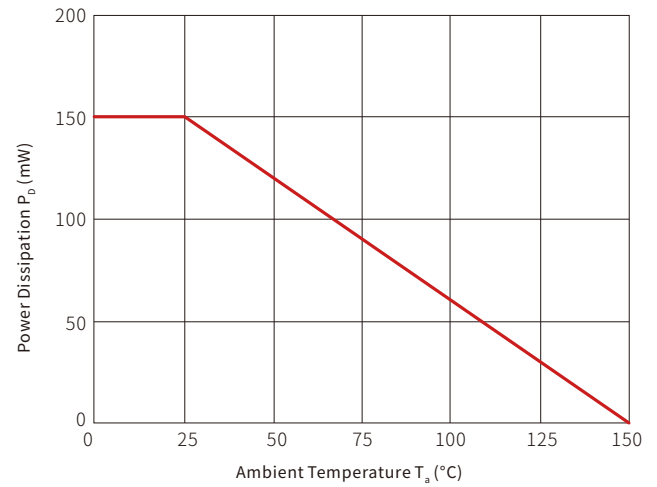
Part Number	Device Marking Code	Zener Voltage Range (Note 1)				Maximum Zener Impedance (Note 2)			Maximum Reverse Current		Typical temperature coefficient @I <sub>ZT</sub> mV/°C	
		V <sub>Z</sub> @I <sub>ZT</sub>			I <sub>ZT</sub>	Z <sub>ZT</sub> @I <sub>ZT</sub>	Z <sub>ZK</sub> @I <sub>ZK</sub>		I <sub>R</sub>	V <sub>R</sub>	Min	Max
		Nom(V)	Min(V)	Max(V)	(mA)	(Ω)	(mA)	(uA)	(V)			
BZX584B2V4	2V1	2.4	2.35	2.45	5	100	600	1.0	50	1.0	-3.5	0
BZX584B2V7	2V2	2.7	2.65	2.75	5	100	600	1.0	20	1.0	-3.5	0
BZX584B3V0	2V3	3.0	2.94	3.06	5	95	600	1.0	10	1.0	-3.5	0
BZX584B3V3	2V4	3.3	3.23	3.37	5	95	600	1.0	5	1.0	-3.5	0
BZX584B3V6	2V5	3.6	3.53	3.67	5	90	600	1.0	5	1.0	-3.5	0
BZX584B3V9	2V6	3.9	3.82	3.98	5	90	600	1.0	3	1.0	-3.5	0
BZX584B4V3	2V7	4.3	4.21	4.39	5	90	600	1.0	3	1.0	-3.5	0
BZX584B4V7	2Z1	4.7	4.61	4.79	5	80	500	1.0	3	2.0	-3.5	0.2
BZX584B5V1	2Z2	5.1	5.00	5.20	5	60	480	1.0	2	2.0	-2.7	1.2
BZX584B5V6	2Z3	5.6	5.49	5.71	5	40	400	1.0	1	2.0	-2.0	2.5
BZX584B6V2	2Z4	6.2	6.08	6.32	5	10	150	1.0	3	4.0	0.4	3.7
BZX584B6V8	2Z5	6.8	6.66	6.94	5	15	80	1.0	2	4.0	1.2	4.5
BZX584B7V5	2Z6	7.5	7.35	7.65	5	15	80	1.0	1	5.0	2.5	5.3
BZX584B8V2	2Z7	8.2	8.04	8.36	5	15	80	1.0	0.7	5.0	3.2	6.2
BZX584B9V1	2Z8	9.1	8.92	9.28	5	15	100	1.0	0.5	6.0	3.8	7.0
BZX584B10	2Z9	10	9.80	10.20	5	20	150	1.0	0.2	7.0	4.5	8.0
BZX584B11	2Y1	11	10.78	11.22	5	20	150	1.0	0.1	8.0	5.4	9.0
BZX584B12	2Y2	12	11.76	12.24	5	25	150	1.0	0.1	8.0	6.0	10.0
BZX584B13	2Y3	13	12.74	13.26	5	30	170	1.0	0.1	8.0	7.0	11.0
BZX584B15	2Y4	15	14.70	15.30	5	30	200	1.0	0.1	10.5	9.2	13.0
BZX584B16	2Y5	16	15.68	16.32	5	40	200	1.0	0.1	11.2	10.4	14.0
BZX584B18	2Y6	18	17.64	18.36	5	45	225	1.0	0.1	12.6	12.4	16.0
BZX584B20	2Y7	20	19.60	20.40	5	55	225	1.0	0.1	14.0	14.4	18.0
BZX584B22	2Y8	22	21.56	22.44	5	55	250	1.0	0.1	15.4	16.4	20.0
BZX584B24	2Y9	24	23.52	24.48	5	70	250	1.0	0.1	16.8	18.4	22.0
BZX584B27	2X1	27	26.46	27.54	2	80	300	0.5	0.1	18.9	21.4	25.3
BZX584B30	2X2	30	29.40	30.60	2	80	300	0.5	0.1	21.0	24.4	29.4
BZX584B33	2X3	33	32.34	33.66	2	80	325	0.5	0.1	23.1	27.4	33.4
BZX584B36	2X4	36	35.28	36.72	2	90	350	0.5	0.1	25.2	30.4	37.4
BZX584B39	2X5	39	38.22	39.78	2	130	350	0.5	0.1	27.3	33.4	41.2
BZX584B43	2X6	43	42.14	43.86	2	100	700	1.0	0.1	32.0	10.0	12.0
BZX584B47	2X7	47	46.06	47.94	2	100	750	1.0	0.1	35.0	10.0	12.0

**Notes:**

1. Tested with pulses, period=5ms, pulse width =300μs.
2. f = 1 kHz

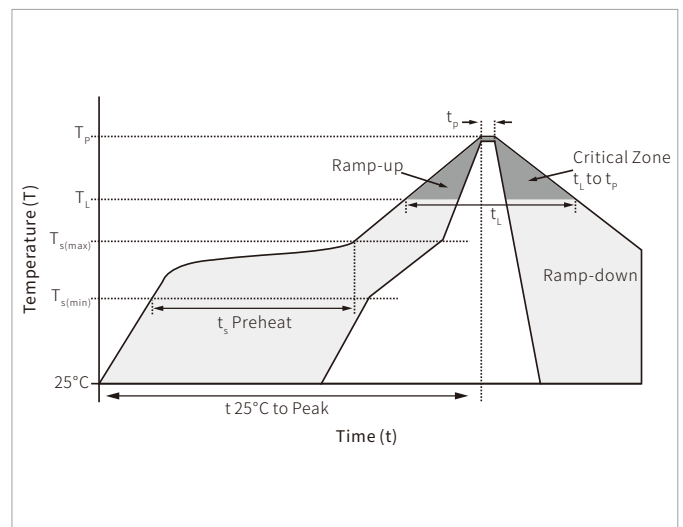
# CHARACTERISTIC CURVES



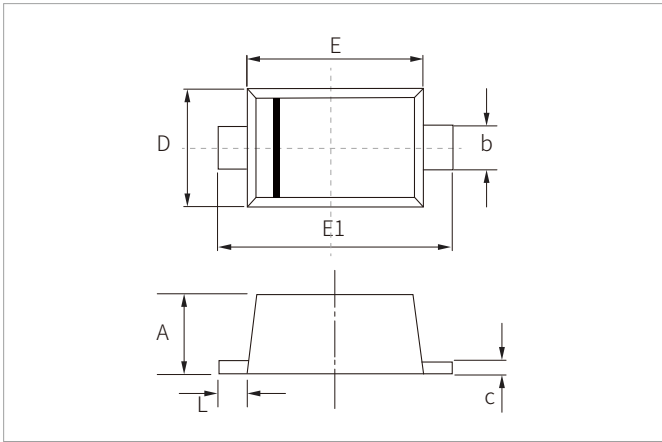
**Effect of Zener Voltage on Zener Impedance**

**Power Derating Curve**


## SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ( $T_{s(min)}$ )	150°C
	Temperature Max ( $T_{s(max)}$ )	200°C
	Time (min to max) ( $t_s$ )	60 – 180 secs
Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak)		3°C/second max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/second max
Reflow	Temperature ( $T_L$ ) (Liquidus)	217°C
	Time (min to max) ( $t_L$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		260°C
Time within 5°C of actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes max.
Do not exceed		260°C

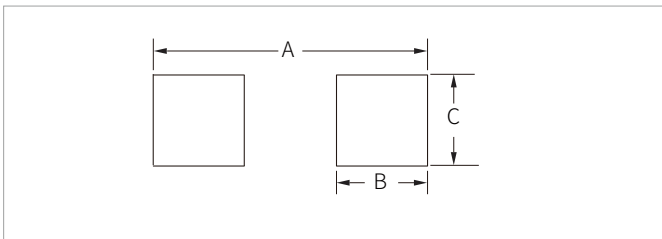


## SOD-523 PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.50	0.80	0.020	0.031
b	0.25	0.35	0.010	0.014
c	0.07	0.20	0.003	0.008
D	0.70	0.90	0.028	0.035
E	1.10	1.30	0.043	0.051
E1	1.50	1.70	0.059	0.067
L	0.15	0.25	0.006	0.010

## RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters	Inches
	Min.	Min.
A	2.00	0.0787
B	0.60	0.0236
C	0.70	0.0276

## ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
BZX584B2V4-BZX584B47	SOD-523	3000PCS	7"

**Headquarters**

No.3387 Shendu Road  
Pujiang I&E Park  
Minhang Shanghai China  
201000

**Hotline**

400-021-5756

**Web**

<https://www.semiware.com>

**Sales Center**

Tel: 86-21-3463-7458  
Email: [sales18@semiware.com](mailto:sales18@semiware.com)

**Customer Service**

Tel: 86-21-5484-1001  
Email: [sales17@semiware.com](mailto:sales17@semiware.com)

**Technical Support**

Tel: 86-21-3463-7654  
Email: [fae01@semiware.com](mailto:fae01@semiware.com)

**Complaint & Suggestions**

Tel: 86-21-3463-7172  
Ext: 8868  
Email: [cs03@semiware.com](mailto:cs03@semiware.com)

**By QR Code**

Website



Wechat

To find your local partner within Semiware' s global website: [www.semiware.com](http://www.semiware.com)

© 2022 Semiware Semiconductor Inc.

The content of this document has been carefully checked and understood. However, neither Semiware nor its subsidiaries assume any liability whatsoever for any errors or inaccuracies of this document and the consequences thereof. Published specifications are subject to change without notice. Product suitability for any area of application must ultimately be determined by the customer. In all cases, products must never be operated outside their published specifications. Semiware does not guarantee the availability of all published products. This disclaimer shall be governed by substantive Chinese law and resulting disputes shall be settled by the courts at the place of business of Semiware. Latest publications and a complete disclaimer can be downloaded from the Semiware website. All trademarks recognized.